

Declaration, Power of Attorney and Petition

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10/01

WE (I) the undersigned inventor(s), hereby declare(s) that:

My residence, post office address and citizenship are as stated below next to my name,

We (I) believe that we are (I am) the original, first and joint (sole) inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled

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X 10 10 10 10 10 10 10 10 10 10 10 10 10		RELAY AMP	LIFIER						
the specification of	of which								
	is attached	d hereto.							
	was filed	on		_ as					
	Application								
	and amen								
\boxtimes									
	Number	PCT/JP2004	l/012229		-				
	on Au	gust 19, 2004			• *				
	and was a	mended under	PCT Article 1	9					
	on		(if a	pplicable).					
We (I) ackno as defined in Sect We (I) hereby application(s) for at least one count	ms, as ame wledge the ion 1.56 of claim fo patent or i ry other th	ended by any are e duty to discle f Title 37 Code preign priority inventor's certi- nan the United	se information of Federal Rep benefits und ficate, or § 36 States, listed b	known to be mate	rial to the patent 119(a)-(d) or § nternational applico identified belo	ability of 365(b) lication w ow, by ch	this ap of any hich d	pplica y for lesign g the	eign ated box,
				. Prior Foreign Ap			-	-	
Application	No.	C	Country	Day/M	Ionth/Year		Prio Clair		
P2003-2080)66		Japan	20/Au	gust/2003	\boxtimes	Yes		No
							Yes		No
							Yes		No
							Yes		No
							Yes		No

三菱27川別以株式会社提03P03307US,三菱電旅祥式会社技 OSP19738 宜整生修状 (2/4)

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We (I) hereby claim the benefit uncapplication(s) listed below.	der Title 35, United St	tates Code, § 119(e) of any U	United States provisional
(Application Number)		(Filing Date)	-
(Application Number)	 -	(Filing Date)	-
We (I) hereby claim the benefit und any PCT International application design each of the claims of this application is the manner provided by the first paragra is material to patentability as defined in application and the national or PCT Inter-	gnating the United State not disclosed in the p ph of 35 U.S.C. § 112, 37 CFR § 1.56 which	tes, listed below and, insofar rior United States or PCT In I acknowledge the duty to di became available between the	as the subject matter of ternational application in sclose information which
Application Serial No.	Filing Date		(pending, patented, abandoned)
And we (I) hereby appoint the follow	owing registered practi	tioner(s):	
	22850		
as our (my) attorneys, with full powers of business in the Patent Office connected application be sent to			
	22850	1 80 13 18 81	
We (I) declare that all statements m on information and belief are believed that willful false statements and the like of Title 18 of the United States Code application or any patent issuing thereon	to be true; and further so made are punishable and that such willful	that these statements were ne by fine or imprisonment, or	hade with the knowledge both, under Section 1001
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Date	 	12-14, Koishikawa 1-chome, Bunk	

三菱2711P1U株成社模U3P03307US,三菱電旅程式会社模 OSP19938 宣弗多伦林(3/4)

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